# 2SB0937 (2SB937), 2SB0937A (2SB937A)

## Silicon PNP epitaxial planar type Darlington

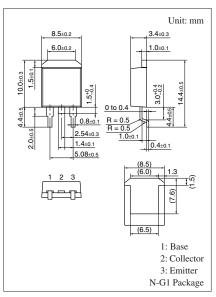
For power amplification and switching Complementary to 2SD1260, 2SD1260A

#### ■ Features

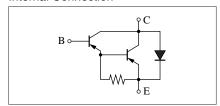
- $\bullet$  High forward current transfer ratio  $h_{\!F\!E}$
- High-speed switching
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SB0937	V <sub>CBO</sub>	-60	V
(Emitter open)	2SB0937A		-80	
Collector-emitter voltage	2SB0937	V <sub>CEO</sub>	-60	V
(Base open)	2SB0937A		-80	
Emitter-base voltage (Col	$V_{EBO}$	-5	V	
Collector current	$I_C$	-2	A	
Peak collector current	$I_{CP}$	-4	A	
Collector power dissipation	P <sub>C</sub>	35	W	
	$T_a = 25$ °C		1.3	
Junction temperature	$T_{j}$	150	°C	
Storage temperature	$T_{stg}$	-55 to +150	°C	



Note) Self-supported type package is also prepared. Internal Connection



### ■ Electrical Characteristics $T_C = 25$ °C $\pm 3$ °C

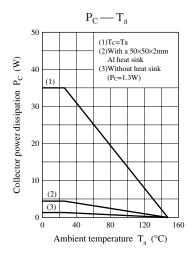
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0937	V <sub>CEO</sub>	$I_C = -30 \text{ mA}, I_B = 0$	-60			V
(Base open)	2SB0937A			-80			
Base-emitter voltage		$V_{BE}$	$V_{CE} = -4 \text{ V}, I_{C} = -2 \text{ A}$			-2.8	V
Collector-base cutoff	2SB0937	$I_{CBO}$	$V_{CB} = -60 \text{ V}, I_E = 0$			-1	mA
current (Emitter open)	2SB0937A		$V_{CB} = -80 \text{ V,} I_{E} = 0$			-1	
Collector-emitter cutoff	2SB0937	$I_{CEO}$	$V_{CE} = -30 \text{ V}, I_B = 0$			-2	mA
current (Base open)	2SB0937A		$V_{CE} = -40 \text{ V}, I_B = 0$			-2	
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = -5 \text{ V}, I_{C} = 0$			-2	mA
Forward current transfer rat	io	h <sub>FE1</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	1 000			_
		h <sub>FE2</sub> *	$V_{CE} = -4 \text{ V}, I_{C} = -2 \text{ A}$	2000		10 000	
Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	$I_C = -2 \text{ A}, I_B = -8 \text{ mA}$			-2.5	V
Transition frequency		$f_T$	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t <sub>on</sub>	$I_C = -2 A$ ,		0.4		μs
Strage time		t <sub>stg</sub>	$I_{B1} = -8 \text{ mA}, I_{B2} = 8 \text{ mA}$		1.5		μs
Fall time		$t_{\rm f}$	$V_{CC} = -50 \text{ V}$		0.5		μs

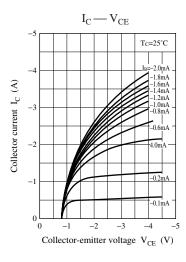
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

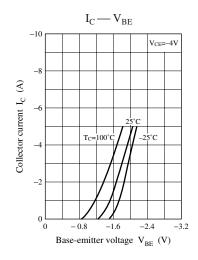
#### 2. \*: Rank classification

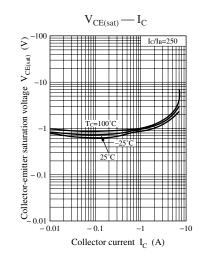
Rank	Q	Р		
h <sub>FE1</sub>	2000 to 5000	4000 to 10000		

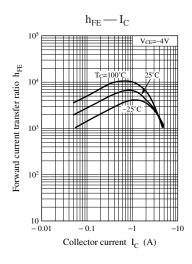
Note) The part number in the parenthesis shows conventional part number.

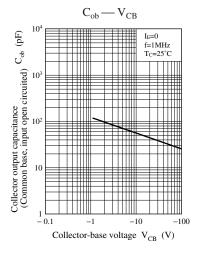


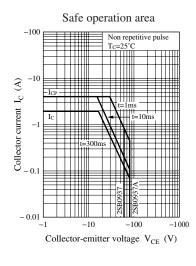


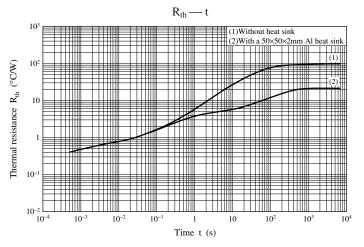












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